

DOUBLE BALANCED MODULATOR/DEMODULATOR

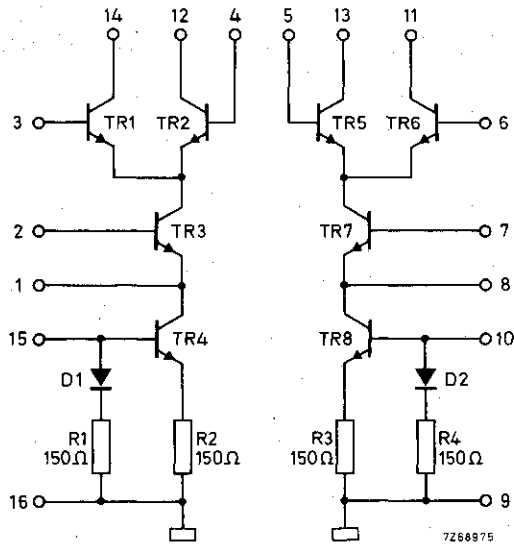
The TCA240 is a monolithic integrated circuit used for general purpose applications, such as:

- modulator
- mixer
- switch/chopper
- a.m. synchronous demodulator
- f.m. quadrature demodulator
- phase comparator
- differential amplifier

The circuit is arranged to offer very flexible circuit design possibilities. The excellent matching and temperature tracking of the transistors in the circuit allows the use of circuit techniques which are not available when using discrete devices.

PACKAGE OUTLINE plastic 16-lead dual in-line (see general section).

CIRCUIT DIAGRAM



Note

Pins 16 and 9 are connected to the substrate.

When both long tailed pairs are used connect pin 9 with pin 16 externally.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages (each transistor)

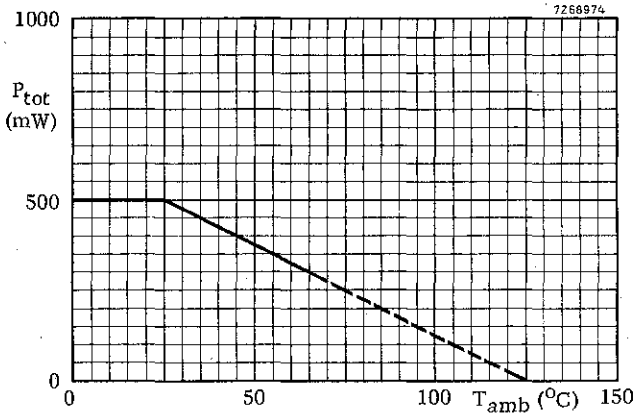
Collector-substrate voltage (open base and emitter)	V_{CSO}	max.	16 V
Collector-base voltage (open emitter)	V_{CBO}	max.	16 V
Collector-emitter voltage (open base)	V_{CEO}	max.	12 V
Emitter-base voltage (open collector)	V_{EBO}	max.	5 V

Currents (each transistor)

Emitter current	I_E	max.	10 mA
Base current	I_B	max.	10 mA

RATINGS (continued)

Total power dissipation (mounted on a printed-wiring board)



Temperatures

Storage temperature

T_{stg} -55 to +125 $^{\circ}C$

Operating ambient temperature

T_{amb} -20 to +70 $^{\circ}C$

Crystal temperature

T_c max. 125 $^{\circ}C$

THERMAL RESISTANCE

From crystal to ambient

$R_{th\ j-a}$ = 200 $^{\circ}C/W$



CHARACTERISTICS at $V_{11-9} = V_{13-9} = V_{12-16} = V_{14-16} = 12 \text{ V}$;
 $V_{3-16} = V_{4-16} = V_{5-9} = V_{6-9} = 6 \text{ V}$; $V_{2-16} = V_{7-9} = 4 \text{ V}$;
 $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; unless otherwise specified

Collector current difference

between transistors TR4 and TR8
 $I_{10} = I_{15} = 1.5 \text{ mA}$

$$|I_{C4} - I_{C8}| < 0.07 \text{ mA}$$

Base-emitter voltage

of transistors TR3 and TR7
 $I_1 = I_8 = -1 \text{ mA}$

$$V_{BE3}; V_{BE7} \quad 690 \text{ to } 770 \text{ mV}$$

Base-emitter voltage difference

between transistors TR1 and TR2
 $V_{12-16} = V_{14-16} = 10 \text{ V}$; $I_{15} = 1.5 \text{ mA}$

$$|V_{BE1} - V_{BE2}| < 2.5 \text{ mV}$$

between transistors TR5 and TR6
 $V_{11-9} = V_{13-9} = 10 \text{ V}$; $I_{10} = 1.5 \text{ mA}$

$$|V_{BE5} - V_{BE6}| < 2.5 \text{ mV}$$

between the parallel connection of
 TR1, TR5 and TR2, TR6
 $V_{11-9} = V_{13-9} = V_{12-16} = V_{14-16} = 8 \text{ V}$
 $I_1 + I_8 = -3 \text{ mA}$

$$|V_{BE1;5} - V_{BE2;6}| < 2.1 \text{ mV}$$

D. C. current gain

of transistors TR3 and TR7
 $I_1 + I_8 = -3 \text{ mA}$

$$h_{FE3}, h_{FE7} \quad 23 \text{ to } 190$$

D. C. current gain ratio

of transistors TR3 and TR7
 $I_1 + I_8 = -3 \text{ mA}$

$$\left| \frac{h_{FE3} - h_{FE7}}{h_{FE3} + h_{FE7}} \right| \times 200 \quad 0 \text{ to } 60 \%$$

D. C. current gain

of transistors TR1, TR2, TR5 and TR6
 $I_E = 750 \text{ } \mu\text{A}$

$$h_{FE1}, h_{FE2}, h_{FE5}, h_{FE6} \quad 23 \text{ to } 190$$

D. C. current gain ratio

of transistors TR1 and TR2
 $I_1 = -1.5 \text{ mA}$

$$\left| \frac{h_{FE1} - h_{FE2}}{h_{FE1} + h_{FE2}} \right| \times 200 \quad 0 \text{ to } 60 \%$$

of transistors TR5 and TR6
 $I_8 = -1.5 \text{ mA}$

$$\left| \frac{h_{FE5} - h_{FE6}}{h_{FE5} + h_{FE6}} \right| \times 200 \quad 0 \text{ to } 60 \%$$

CHARACTERISTICS (continued)

D. C. current gain

of the parallel connection of TR1 and TR6 at $I_1 + I_8 = -3$ mA	h_{FE1}, h_{FE6}	23 to 190
of the parallel connection of TR2 and TR5 at $I_1 + I_8 = -3$ mA	h_{FE2}, h_{FE5}	23 to 190

D. C. current gain ratio

of the parallel connection of TR1, TR6 and TR2, TR5 $I_1 + I_8 = -3$ mA	$\left \frac{h_{FE1;6} - h_{FE2;5}}{h_{FE1;6} + h_{FE2;5}} \right \times 200$	0 to 60 %
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DYNAMIC DESIGN DATA

Noise figure at f = 100 MHz

$I_C = 1$ mA; $V_{CB} = 5$ V; $G_S = 3,7$ mA/V; $B_S = -2,5$ mA/V	F	<	3,7	dB
$I_E = 2,5$ mA; $V_{CB} = 5$ V; $G_S = 6,5$ mA/V; $B_S = -2,5$ mA/V	F	<	4,2	dB

y parameters

$V_{CE} = 5$ V; $f = 100$ MHz

		$I_E = 1$ mA	$I_E = 5$ mA	
Input conductance	g_{ie} typ.	4,4	13,6	mA/V
Input susceptance	b_{ie} typ.	7,6	9	mA/V
Feedback admittance	$ y_{re} $ typ.	0,4	0,4	mA/V
Phase angle of feedback admittance	$-\varphi_{re}$ typ.	100°	100°	
Transfer admittance	$ y_{fe} $ typ.	22	55	mA/V
Phase angle of feedback admittance	$-\varphi_{fe}$ typ.	45°	96°	
Output conductance	g_{oe} typ.	0,4	0,5	mA/V
Output susceptance	b_{oe} typ.	1,8	1,8	mA/V

Frequency response (see circuit on page 6)

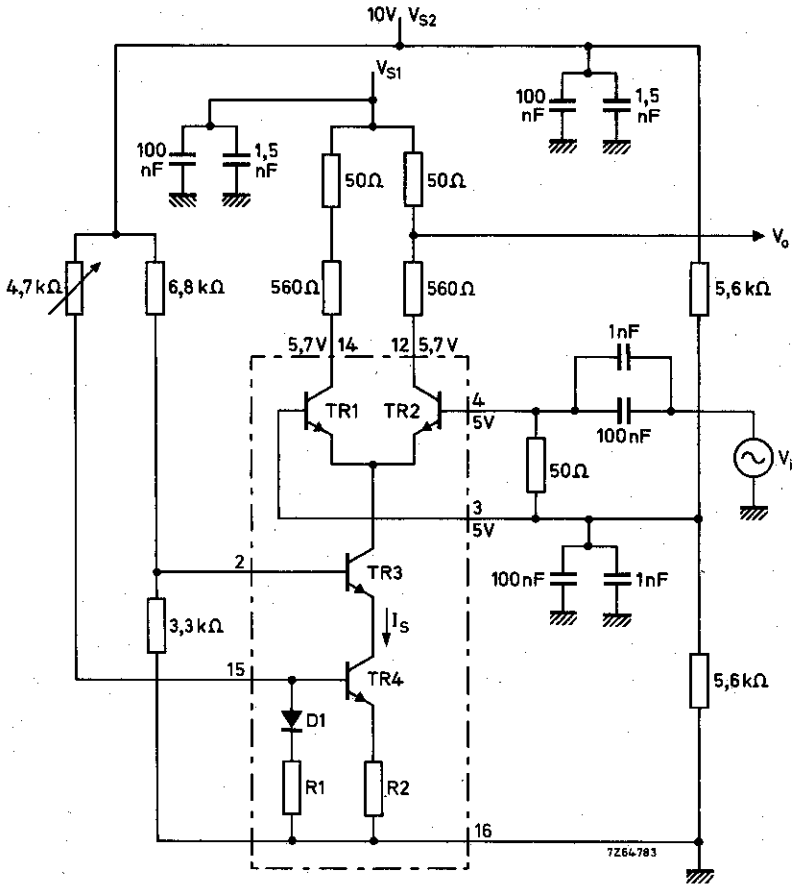
$I_S = 5$ mA; $R_C = 600 \Omega$; $f = -3$ dB	f typ.	34	MHz
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Switching times (see circuit on page 7)

	$I_S =$	0,5	1	2	4	mA
Rise time	t_r typ.	2,9	2,7	2,7	3,1	ns
Fall time	t_f typ.	1,4	1,3	1,6	2,3	ns
Rise propagation delay time ¹⁾	t_{pdr} typ.	1,1	1,2	1,4	1,7	ns
Fall propagation delay time ¹⁾	t_{pdf} typ.	1,1	1,2	1,4	1,7	ns

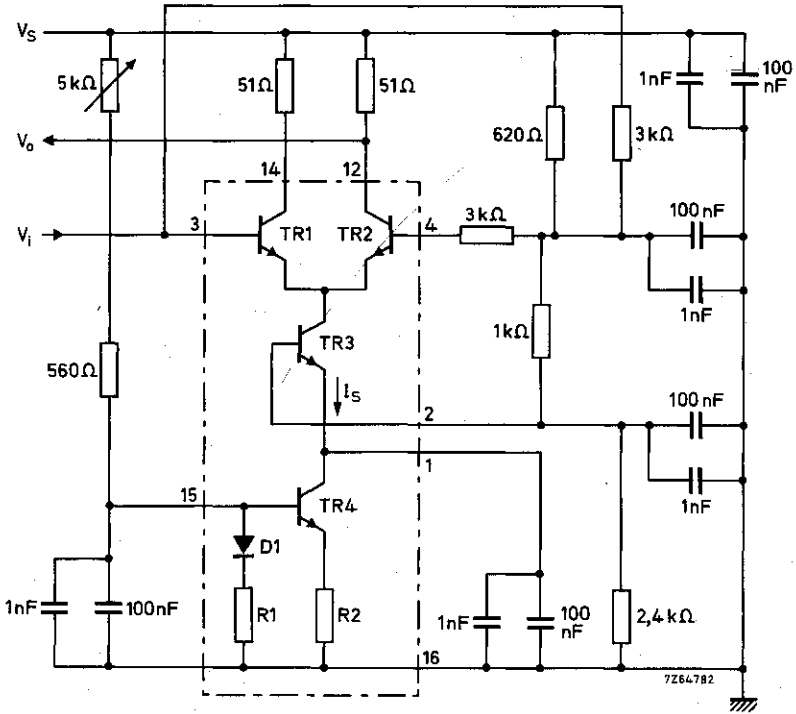
¹⁾ Reference level 50 %.

DYNAMIC DESIGN DATA (continued)



Circuit for measuring the frequency response

DYNAMIC DESIGN DATA (continued)

Circuit for measuring t_r , t_f , t_{pdR} and t_{pdf}